TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π -MOSIII)

2SK2884

Chopper Regulator, DC-DC Converter Applications

- Low drain-source ON resistance : $R_{DS (ON)} = 1.9 \Omega$ (typ.)
- High forward transfer admittance : |Y_{fs}| = 3.8 S (typ.)
- Low leakage current : $I_{DSS} = 100 \ \mu A \ (max) \ (V_{DS} = 640 \ V)$
- Enhancement mode : $V_{th} = 2.0$ to $4.0 \text{ V} (V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA})$

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Drain-source voltage		V _{DSS}	800	
Drain-gate voltage (R _{GS} = 20 kΩ)		V _{DGR}	800	$\langle v \rangle$
Gate-source voltage		V _{GSS}	±30	v
Drain current	DC (Note 1)	۱ _D	5	Ă
	Pulse (Note 1)	I _{DP}	15	~ А
Drain power dissipation (Tc=25°C)		PD	100	W
Single pulse avalanche energy (Note 2)		Eas <	370	mJ
Avalanche current		IAR	5	A
Repetitive avalanche energy (Note 3)		EAR)) 10	mJ
Channel temperature		Tch	150 <	°C
Storage temperature range		Tstg	-55 to 150)°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

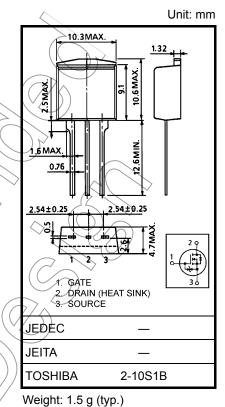
Thermal Characteristics

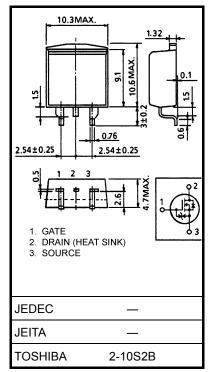
Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	Rth (ch-c)	1.25	°C / W
Thermal resistance, channel to ambient	R _{th (ch−a)}	83.3	°C / W

Note 1: Ensure that the channel temperature does not exceed 150°C.

- Note 2: V_{DD} = 90 V, T_{ch} = 25°C (initial), L = 27 mH, R_G = 25 Ω , I_{AR} = 5 A
- Note 3: Repetitive rating: pulse width limited by maximum channel temperature.

This transistor is an electrostatic-sensitive device. Please handle with caution.





Weight: 1.5 g (typ.)

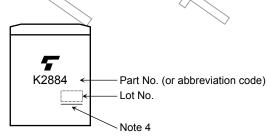
Electrical Characteristics (Ta = 25°C)

Charao	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	urrent	I _{GSS}	V_{GS} = ±30 V, V_{DS} = 0 V	_	—	±10	μA
Gate-source bre	eakdown voltage	V (BR) GSS	I _G = ±10 μA, V _{DS} = 0 V	±30	_	_	V
Drain cut-off cu	rrent	I _{DSS}	V _{DS} = 640 V, V _{GS} = 0 V	Ŋ	_	100	μA
Drain-source br	eakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	800		_	V
Gate threshold v	voltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	2.0	-7(4.0	V
Drain-source O	N resistance	R _{DS (ON)}	V _{GS} = 10 V, I _D = 3 A		1.9	2.2	Ω
Forward transfe	r admittance	Y _{fs}	V _{DS} = 15 V, I _D = 3 A	1.0	3.8	_	S
Input capacitance	ce	C _{iss}			1080		
Reverse transfer capacitance		C _{rss}	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz		16		pF
Output capacitance		C _{oss}		-	105	1	
Ti Switching time	Rise time	tr	$V_{GS} \stackrel{10V}{}_{OV} \prod \stackrel{I_{D}=3A}{}_{VOUT}$	- (40	>	
	Turn-on time	t _{on}	$\begin{array}{c} 0 \\ 0 \\ 0 \\ 0 \\ 0 \\ 0 \\ 0 \\ 0 \\ 0 \\ 0 $	C V	80) _	
	Fall time	t _f		$\overline{\mathcal{A}}$	40	_	ns
	Turn-off time	t _{off}	$Duty \leq 1\%, t_{W} = 10 \mu s$) –	140	_	
Total gate charg plus gate-drain)		Qg			34		
Gate-source charge		Q _{gs}	$V_{DD} \approx 400 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 5 \text{ A}$	_	16	_	nC
Gate-drain ("miller") Charge		Qgd		_	18	_	

Source–Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)		-	_	_	5	А
Pulse drain reverse current (Note 1)	I _{DRP}	-	_		15	A
Forward voltage (diode)		I _{DR} = 5 A, V _{GS} = 0 V	_	-	-1.9	V
Reverse recovery time	trr	I _{DR} = 5 A, V _{GS} = 0 V		1000		ns
Reverse recovery charge	Qrr	dl _{DR} / dt = 100 A / μs	_	7.5	_	μC

Marking



Note 4: A line under a Lot No. identifies the indication of product Labels.

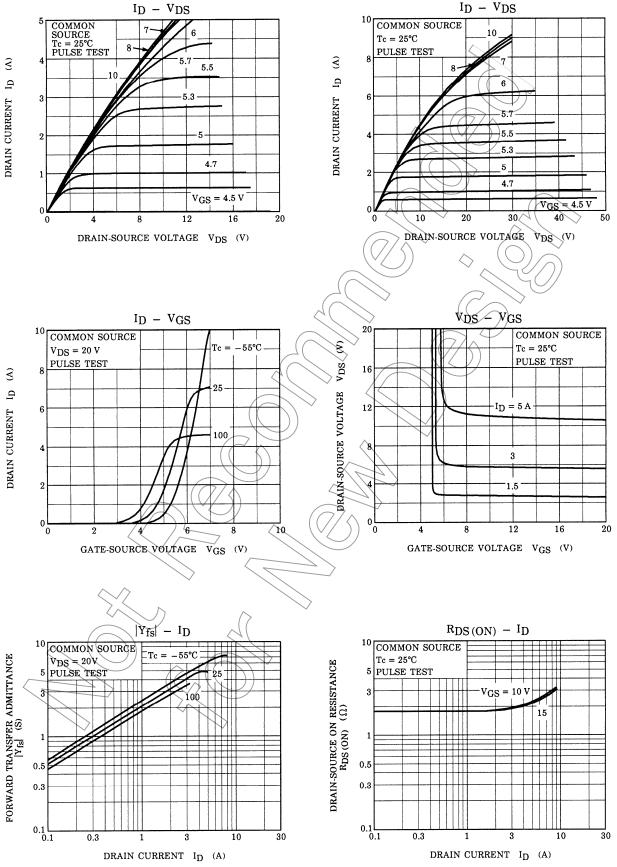
Not underlined: [[Pb]]/INCLUDES > MCV

Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

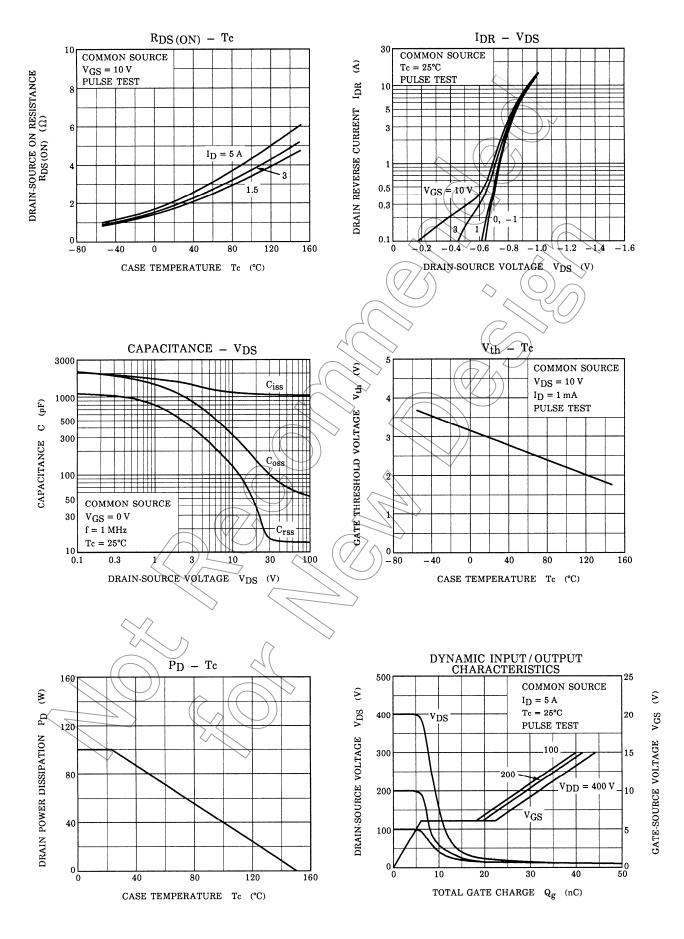
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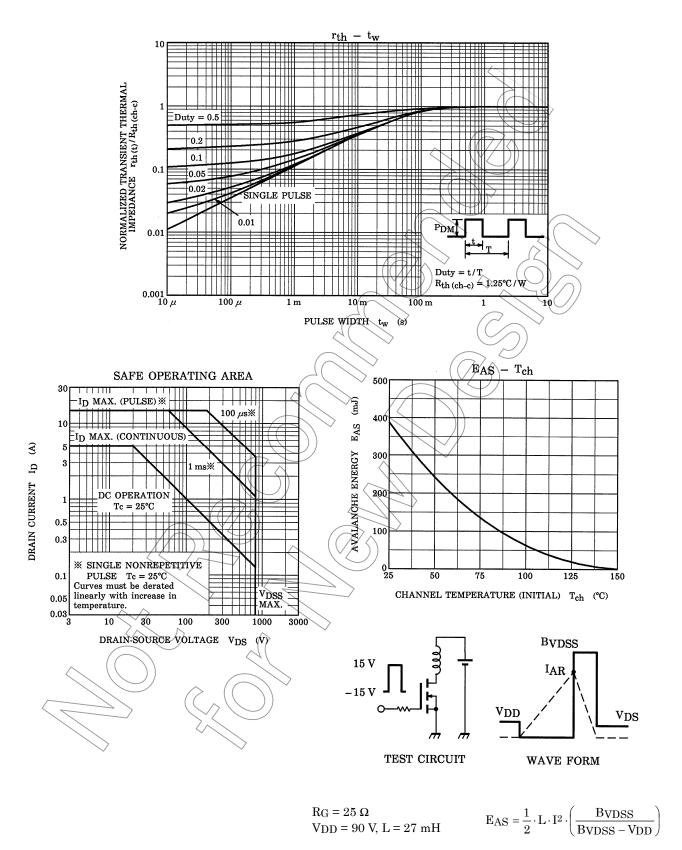
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